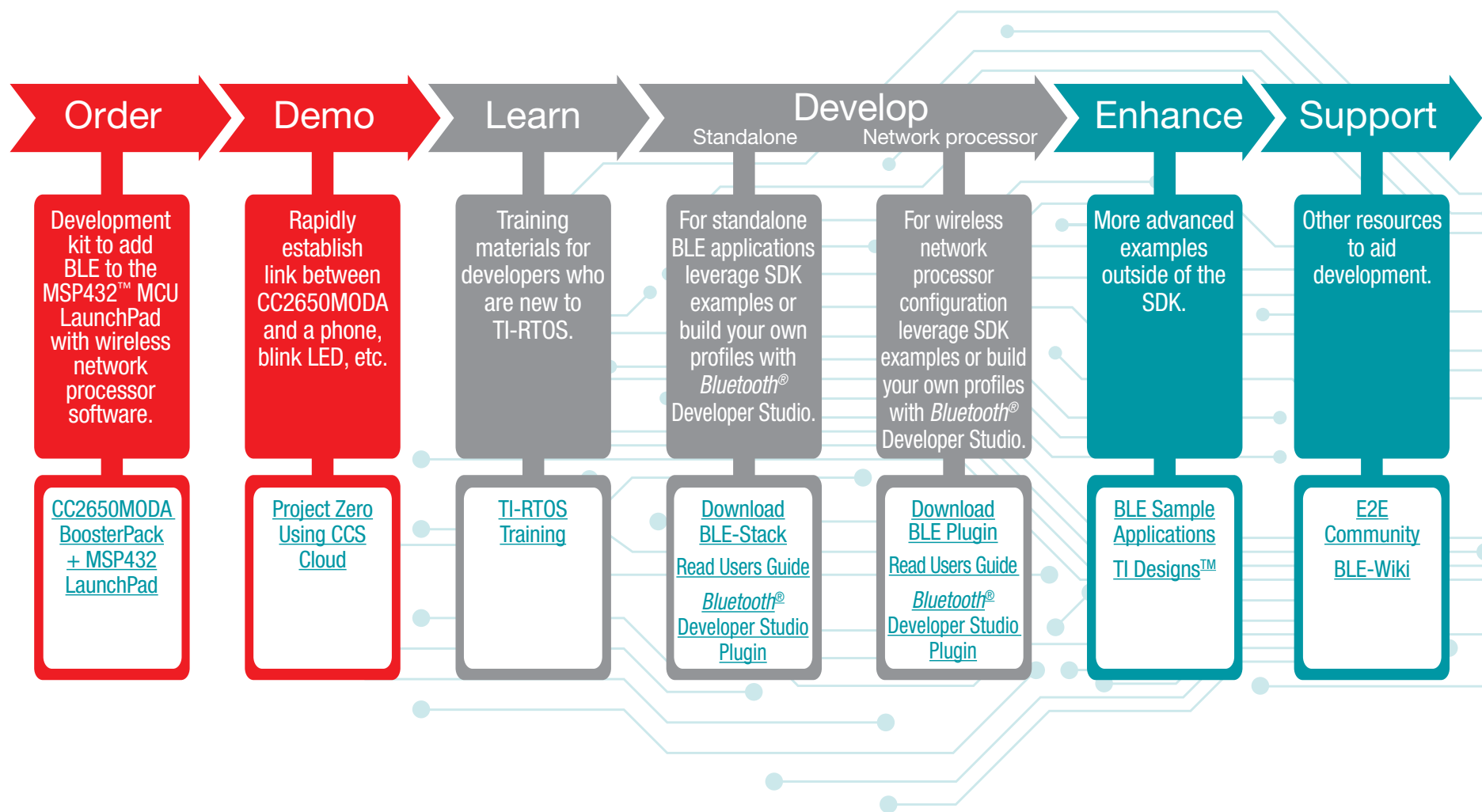


Getting started with *Bluetooth*[®] low energy CC2650MODA for CCS users

Pre-certified *Bluetooth*[®] low energy module, *Bluetooth*[®] 4.2 compliant



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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
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